

Small Signal Transistor (PNP)

Features

- PNP Silicon Epitaxial Planar Transistor for switching and amplifier applications.

Mechanical Data

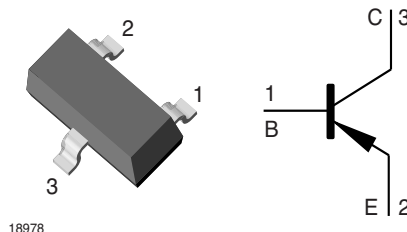
Case: SOT-23 Plastic case

Weight: approx. 8.8 mg

Packaging Codes/Options:

GS18 / 10 k per 13" reel (8 mm tape), 10 k/box

GS08 / 3 k per 7" reel (8 mm tape), 15 k/box



Parts Table

Part	Ordering code	Marking	Remarks
MMBT2907A	MMBT2907A-GS18 or MMBT2907A-GS08	2F	Tape and Reel

Absolute Maximum Ratings

$T_{amb} = 25\text{ }^{\circ}\text{C}$, unless otherwise specified

Parameter	Test condition	Symbol	Value	Unit
Collector - base voltage		$-V_{CBO}$	60	V
Collector - emitter voltage		$-V_{CEO}$	60	V
Emitter - base voltage		$-V_{EBO}$	5.0	V
Collector current		$-I_C$	600	mA
Power dissipation ¹⁾	$T_A = 25\text{ }^{\circ}\text{C}$	P_{tot}	225	mW
	Derate above $25\text{ }^{\circ}\text{C}$	P_{tot}	1.8	mW/ $^{\circ}\text{C}$
Power dissipation ²⁾	$T_A = 25\text{ }^{\circ}\text{C}$	P_{tot}	300	mW
	Derate above $25\text{ }^{\circ}\text{C}$	P_{tot}	2.4	mW/ $^{\circ}\text{C}$

¹⁾ FR-5 Board = 1.0 x 0.75 x 0.062 in.

²⁾ Alumina Substrate = 0.4 x 0.3 x 0.024 x in. 99.5 % alumina.

Maximum Thermal Resistance

Parameter	Test condition	Symbol	Value	Unit
Thermal resistance junction to ambient air FR-5 board		R_{thJA}	556	$^{\circ}\text{C/W}$
Thermal resistance junction to ambient air alumina substrate		R_{thJA}	417	$^{\circ}\text{C/W}$
Junction temperature		T_j	150	$^{\circ}\text{C}$
Storage temperature range		T_S	- 55 to + 150	$^{\circ}\text{C}$

Electrical DC Characteristics

Parameter	Test condition	Symbol	Min	Typ	Max	Unit
DC current gain	- $V_{CE} = 10\text{ V}$, - $I_C = 0.1\text{ mA}$	h_{FE}	75			
	- $V_{CE} = 10\text{ V}$, - $I_C = 1\text{ mA}$	h_{FE}	100			
	- $V_{CE} = 10\text{ V}$, - $I_C = 10\text{ mA}$	h_{FE}	100			
	- $V_{CE} = 10\text{ V}$, - $I_C = 150\text{ mA}^{1)}$	h_{FE}	100		300	
	- $V_{CE} = 10\text{ V}$, - $I_C = 500\text{ mA}^{1)}$	h_{FE}	50			
Collector cut - off current	- $V_{EB} = 0.5\text{ V}$, - $V_{CE} = 30\text{ V}$	- I_{CEV}			50	nA
	- $V_{CB} = 50\text{ V}$, $I_E = 0$	- I_{CBO}			0.01	μA
	- $V_{CB} = 50\text{ V}$, $I_E = 0$, $T_A = 125\text{ }^\circ\text{C}$	- I_{CBO}			10	μA
Emitter - base cut - off current	- $V_{EB} = 0.5\text{ V}$, - $V_{CE} = 30\text{ V}$	- I_{BL}			50	nA
Collector - emitter saturation voltage ¹⁾	- $I_C = 150\text{ mA}$, - $I_B = 15\text{ mA}$	- V_{CEsat}			0.4	V
	- $I_C = 500\text{ mA}$, - $I_B = 50\text{ mA}$	- V_{CEsat}			1.6	V
Base - emitter saturation voltage	- $I_C = 150\text{ mA}$, - $I_B = 15\text{ mA}$	- V_{BEsat}			1.3	V
	- $I_C = 500\text{ mA}$, - $I_B = 50\text{ mA}$	- V_{BEsat}			2.6	V
Collector - emitter breakdown voltage ¹⁾	- $I_C = 10\text{ }\mu\text{A}$, $I_B = 0$	- $V_{(BR)CEO}$	60			V
Collector - base breakdown voltage	- $I_C = 10\text{ }\mu\text{A}$, $I_E = 0$	- $V_{(BR)CBO}$	60			V
Emitter - base breakdown voltage	- $I_E = 10\text{ }\mu\text{A}$, $I_C = 0$	- $V_{(BR)EBO}$	5.0			V

¹⁾ Pulse test: Pulse width $\leq 300\text{ }\mu\text{s}$, duty cycle $\leq 2.0\%$

Electrical AC Characteristics

Parameter	Test condition	Symbol	Min	Typ	Max	Unit
Gain - bandwidth product	- $V_{CE} = 20\text{ V}$, - $I_C = 50\text{ mA}$, $f = 100\text{ MHz}$	f_T	200			MHz
Output capacitance	- $V_{CB} = 10\text{ V}$, $f = 1\text{ MHz}$, $I_E = 0$	C_{ob}			8	pF
Input capacitance	- $V_{EB} = 2\text{ V}$, $f = 1\text{ MHz}$, $I_C = 0$	C_{ibo}			30	pF

Switching Characteristics

Parameter	Test condition	Symbol	Min	Typ	Max	Unit
Turn - ON time	- $I_{B1} = 15\text{ mA}$, - $I_C = 150\text{ mA}$, - $V_{CC} = 30\text{ V}$	t_{on}			45	ns
Delay time	- $I_{B1} = 15\text{ mA}$, - $I_C = 150\text{ mA}$, - $V_{CC} = 30\text{ V}$	t_d			10	ns
Rise time	- $I_{B1} = 15\text{ mA}$, - $I_C = 150\text{ mA}$, - $V_{CC} = 30\text{ V}$	t_r			40	ns
Turn - OFF	- $I_{B1} = 15\text{ mA}$, - $I_C = 150\text{ mA}$, - $V_{CC} = 6\text{ V}$	t_{off}			100	ns
Storage time	- $I_{B1} = -I_{B2} = 15\text{ mA}$, - $I_C = 150\text{ mA}$, - $V_{CC} = 6\text{ V}$	t_s			80	ns
Fall time	- $I_{B1} = -I_{B2} = 15\text{ mA}$, - $I_C = 150\text{ mA}$, - $V_{CC} = 6\text{ V}$	t_f			30	ns

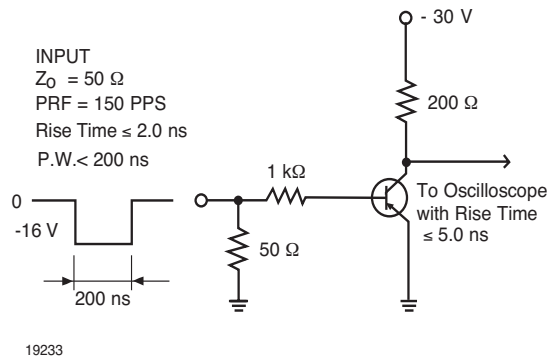


Figure 1. Delay and Rise Time

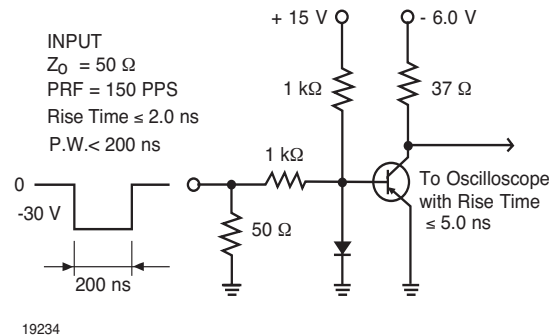
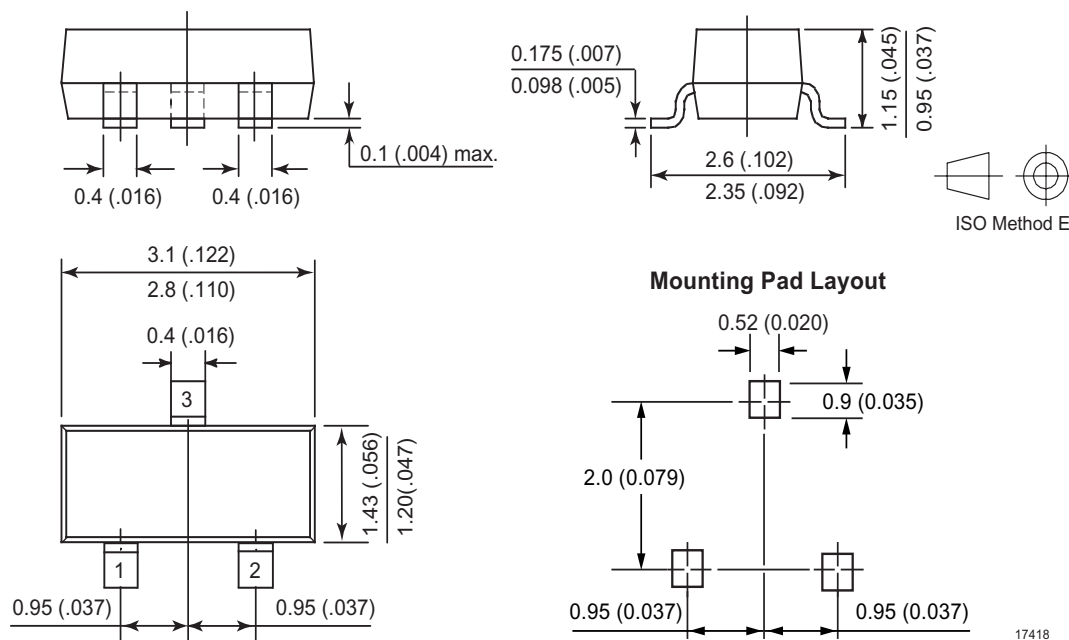


Figure 2. Storage and Fall Time

Package Dimensions in mm (Inches)





Ozone Depleting Substances Policy Statement

It is the policy of Vishay Semiconductor GmbH to

1. Meet all present and future national and international statutory requirements.
2. Regularly and continuously improve the performance of our products, processes, distribution and operating systems with respect to their impact on the health and safety of our employees and the public, as well as their impact on the environment.

It is particular concern to control or eliminate releases of those substances into the atmosphere which are known as ozone depleting substances (ODSs).

The Montreal Protocol (1987) and its London Amendments (1990) intend to severely restrict the use of ODSs and forbid their use within the next ten years. Various national and international initiatives are pressing for an earlier ban on these substances.

Vishay Semiconductor GmbH has been able to use its policy of continuous improvements to eliminate the use of ODSs listed in the following documents.

1. Annex A, B and list of transitional substances of the Montreal Protocol and the London Amendments respectively
2. Class I and II ozone depleting substances in the Clean Air Act Amendments of 1990 by the Environmental Protection Agency (EPA) in the USA
3. Council Decision 88/540/EEC and 91/690/EEC Annex A, B and C (transitional substances) respectively.

Vishay Semiconductor GmbH can certify that our semiconductors are not manufactured with ozone depleting substances and do not contain such substances.

We reserve the right to make changes to improve technical design
and may do so without further notice.

Parameters can vary in different applications. All operating parameters must be validated for each customer application by the customer. Should the buyer use Vishay Semiconductors products for any unintended or unauthorized application, the buyer shall indemnify Vishay Semiconductors against all claims, costs, damages, and expenses, arising out of, directly or indirectly, any claim of personal damage, injury or death associated with such unintended or unauthorized use.

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